## In the Abstract:

## ABSTRACT OF THE DISCLOSURE

Surface-mountable miniature luminescent diode and/or photodiode and method for its production

In the case of a A surface-mountable miniature luminescent diode with a chip package which has a leadframe (16) and a semiconductor chip (22) which is arranged on the leadframe (16) and is in electrical contact with it and which contains an active, radiation-emitting region, according to the invention the .The leadframe (16) is formed by a flexible multi-layered sheet (12, 14).

## Figure 1